IDT707278S/L



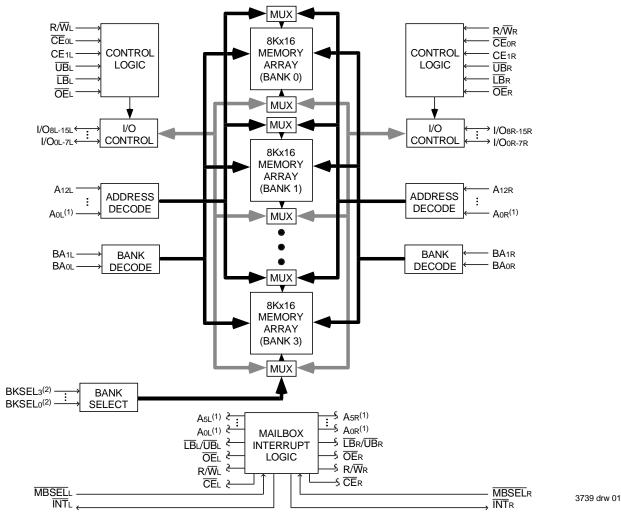
HIGH-SPEED 32K x 16 BANK-SWITCHABLE DUAL-PORTED SRAM WITH EXTERNAL BANK SELECTS

Features

- 32K x 16 Bank-Switchable Dual-Ported SRAM Architecture
 - Four independent 8K x 16 banks
 - 512 Kilobit of memory on chip
- Fast asynchronous address-to-data access time: 15ns
- User-controlled input pins included for bank selects
- Independent port controls with asynchronous address & data busses
- Four 16-bit mailboxes available to each port for interprocessor communications; interrupt option

- Interrupt flags with programmable masking
- Dual Chip Enables allow for depth expansion without external logic
- ◆ UB and LB are available for x8 or x16 bus matching
- TTL-compatible, single 5V (±10%) power supply
- Available in a 100-pin Thin Quad Flatpack (14mm x 14mm)

Functional Block Diagram



NOTES:

- 1. The first six address pins for each port serve dual functions. When MBSEL = VIH, the pins serve as memory address inputs. When MBSEL = VIL, the pins serve as mailbox address inputs.
- 2. Each bank has an input pin assigned that allows the user to toggle the assignment of that bank between the two ports. Refer to Truth Table I for more details.

MAY 2000

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Description

The IDT707278 is a high-speed 32Kx16 (512K bit) Bank-Switchable Dual-Ported SRAM organized into four independent 8Kx16 banks. The device has two independent ports with separate controls, addresses, and I/O pins for each port, allowing each port to asynchronously access any 8Kx16 memory block not already accessed by the other port. Accesses by the ports into specific banks are controlled via bank select pin inputs under the user's control. Mailboxes are provided to allow inter-processor communications. Interrupts are provided to indicate mailbox writes have occurred. An automatic power down feature controlled by the chip enables ($\overline{\text{CE}}0$ and CE1) permits the on-chip circuitry of each port to enter a very low standby power mode and allows fast depth expansion.

The IDT707278 offers a maximum address-to-data access time as fast as 15ns, and is packaged in a 100-pin Thin Quad Flatpack (TQFP).

Functionality

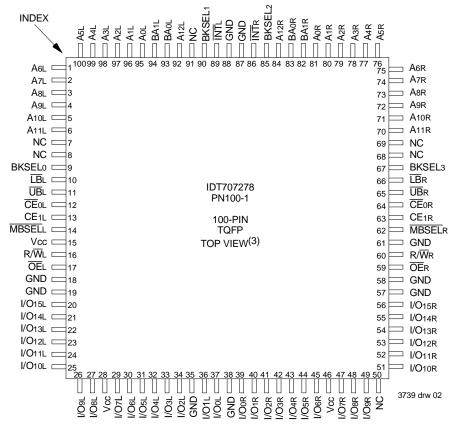
The IDT707278 is a high-speed asynchronous 32K x 16 Bank-Switchable Dual-Ported SRAM, organized in four 8K x 16 banks. The two ports are permitted independent, simultaneous access into separate banks within the shared array. There are four user-controlled Bank Select input pins, and each of these pins is associated with a specific bank within the memory array. Access to a specific bank is gained by placing the associated Bank Select pin in the appropriate state: VIH assigns the bank to the left port, and VIL assigns the bank to the right port (See Truth Table

IV). Once a bank is assigned to a particular port, the port has full access to read and write within that bank. Each port can be assigned as many banks within the array as needed, up to and including all four banks.

The IDT707278 provides mailboxes to allow inter-processor communications. Each port has four 16-bit mailbox registers available to which it can write and read and which the opposite port can read only. These mailboxes are external to the common SRAM array, and are accessed by setting $\overline{\text{MBSEL}} = \text{VIL}$ while setting $\overline{\text{CE}} = \text{VIH}$. Each mailbox has an associated interrupt: a port can generate an interrupt to the opposite port by writing to the upper byte of any one of its four 16-bit mailboxes. The interrupted port can clear the interrupt by reading the upper byte. This read will not alter the contents of the mailbox.

If desired, any source of interrupt can be independently masked via software. Two registers are provided to permit interpretation of interrupts: the Interrupt Cause Register and the Interrupt Status Register. The Interrupt Cause Register gives the user a snapshot of what has caused the interrupt to be generated - the specific mailbox written to. The information in this register provides post-mask signals: Interrupt sources that have been masked will not be updated. The Interrupt Status Register gives the user the status of all bits that could potentially cause an interrupt regardless of whether they have been masked. Truth Table V gives a detailed explanation of the use of these registers.

Pin Configurations^(1,2,3)



NOTES:

- 1. All Vcc pins must be connected to power supply.
- 2. All GND pins must be connected to ground supply.
- 3. Package body is approximately $14mm \times 14mm \times 1.4mm$.
- 4. This package code is used to reference the package diagram.
- 5. This text does not indicate orientation of the actual part-marking.

Pin Names

Ao - A12 ^(1,6)	Address Inputs
BA0 - BA1 ⁽¹⁾	Bank Address Inputs
MBSEL ⁽¹⁾	Mailbox Access Control Gate
BKSEL ₀₋₃ ⁽²⁾	Bank Select Inputs
$R/\overline{W}^{(1)}$	Read/Write Enable
ŌĒ ⁽¹⁾	Output Enable
CE₀, CE₁(¹)	Chip Enables
$\overline{U}\overline{B}$, $\overline{L}\overline{B}^{(1)}$	I/O Byte Enables
I/Oo - I/O15 ⁽¹⁾	Bidirectional Data Input/Output
ĪNT ⁽¹⁾	Interrupt Flag (Output) ⁽³⁾
Vcc ⁽⁴⁾	+5VPower
GND ⁽⁵⁾	Ground

3739 tbl 01

- 1. Duplicated per port.
- Each bank has an input pin assigned that allows the user to toggle the assignment of that bank between the two ports. Refer to Truth Table IV for more details. When changing the bank assignments, accesses of the affected banks must be suspended. Accesses may continue uninterrupted in banks that are not being reallocated.
- 3. Generated upon mailbox access.
- 4. All Vcc pins must be connected to power supply.
- 5. All GND pins must be connected to ground supply.
- The first six address pins (Ao-A5) for each port serve dual functions. When MBSEL = VIH, the pins serve as memory address inputs. When MBSEL = VIL, the pins serve as mailbox address inputs (A6-A12 ignored).

Truth Table I – Chip Enable(1,2,3,4)

ζĒ	Œ₀	CE1	Mode			
	VIL	Vн	Port Selected (TTL Active)			
L	L ≤ 0.2V ≥Vcc -0.2V Port Selected (CMOS Active)					
	VIH	X	Port Deselected (TTL Inactive)			
Н	X	VIL	Port Deselected (TTL Inactive)			
	≥Vcc -0.2V	X	Port Deselected (CMOS Inactive)			
	X	≤0.2V	Port Deselected (CMOS Inactive)			

3739 tbl 02

NOTES:

- 1. Chip Enable references are shown above with the actual $\overline{\text{CE}}_0$ and CE1 levels, $\overline{\text{CE}}$ is a reference only.
- 2. Port "A" and "B" references are located where $\overline{\text{CE}}$ is used.
- 3. "H" = VIH and "L" = VIL.
- 4. $\overline{\text{CE}}$ and $\overline{\text{MBSEL}}$ cannot be active at the same time.

Truth Table II - Non-Contention Read/Write Control

		Inpu	uts ⁽¹⁾			Outputs		
CE(2)	R/W	Œ	ŪB	ĪΒ	MBSEL	I/O8-15	I/O ₀₋₇	Mode
Н	Х	Х	Х	Х	Н	High-Z	High-Z	Deselcted: Power-Down
X ⁽³⁾	Х	Х	Н	Н	X ⁽³⁾	High-Z	High-Z	Both Bytes Deselected
L	L	Х	L	Н	Н	DATAIN	High-Z	Write to Upper Byte Only
L	L	Х	Н	L	Н	High-Z	DATAIN	Write to Lower Byte Only
L	L	Х	L	L	Н	DATAIN	DATAIN	Write to Both Bytes
L	Н	L	L	Н	Н	DATAout	High-Z	Read Upper Byte Only
L	Н	L	Н	L	Н	High-Z	DATAout	Read Lower Byte Only
L	Н	L	L	L	Н	DATAout	DATA out	Read Both Bytes
X ⁽³⁾	Х	Н	Х	Х	X ⁽³⁾	High-Z	High-Z	Outputs Disabled

NOTES:

3739 tbl 03

- 1. BA0L BA1L $^{\rm 1}$ BA0R BA1R: cannot access same bank simultaneously from both ports.
- 2. Refer to Truth Table I.
- 3. CE and MBSEL cannot both be active at the same time.

Truth Table III - Mailbox Read/Write Control⁽¹⁾

		Inp	outs			Out	puts	
CE(2)	R/W	Œ	ŪB	LΒ	MBSEL	I/O8-15	I/O ₀₋₇	Mode
Н	Н	L	X ⁽³⁾	X ⁽³⁾	L	DATAout	DATAout	Read Data from Mailbox, ↓ clears interrupt
Н	Н	L	L	L	L	DATA out	DATAout	Read Data from Mailbox, ↓ clears interrupt
Н	L	Χ	L ⁽³⁾	L ⁽³⁾	L	DATAIN	DATAIN	Write Data into Mailbox
L	Х	Χ	Χ	Χ	L	_	_	Not Allowed

NOTES:

- There are four mailbox locations per port written to and read from all the I/O's (I/Oo-I/O15). These four mailboxes are addressed by Ao-As. Refer to Truth Table V.
- 2. Refer to Truth Table I.
- 3. Each mailbox location contains a 16-bit word, controllable in bytes by setting input levels to $\overline{\sf UB}$ and $\overline{\sf LB}$ appropriately.

Absolute Maximum Ratings(1)

Symbol	Rating	Commercial & Industrial	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7.0	٧
TBIAS	Temperature Under Bias	-55 to +125	°C
Tstg	Storage Temperature	-65 to +150	°C
ЮИТ	DC Output Current	50	mA

Maximum Operating Temperature and Supply Voltage⁽¹⁾

Grade	Grade Ambient Temperature		Vcc
Commercial	0°C to +70°C	0V	5.0V <u>+</u> 10%
Industrial	-40°C to +85°C	0V	5.0V <u>+</u> 10%

NOTES:

3739 tbl 06

1. This is the parameter Ta. This is the "instant on" case temperature.

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. VTERM must not exceed Vcc + 10% for more than 25% of the cycle time or 10ns maximum, and is limited to \leq 20mA for the period of VTERM \geq Vcc + 10%.

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	4.5	5.0	5.5	٧
GND	Ground	0	0	0	V
VIH	Input High Voltage	2.2	_	6.0(2)	V
VIL	Input Low Voltage	-0.5 ⁽¹⁾	_	0.8	V

NOTES:

3739 tbl 07

(Ta = +25°C, f = 1.0MHz) TQFP Package

Symbol	Parameter	Conditions ⁽²⁾	Max.	Unit
Cin	Input Capacitance	VIN = 3dV	9	pF
Соит ⁽³⁾	Output Capacitance	Vout = 3dV	10	pF

3739 tbl 08

3739 tbl 05

NOTES:

- This parameter is determined by device characterization but is not production tested.
- 3dV represents the interpolated capacitance when the input and output signals switch from 0V to 3V or from 3V to 0V.
- 3. Cout represents Ci/o as well.

Capacitance⁽¹⁾

- 1. $VIL \ge -1.5V$ for pulse width less than 10ns.
- VTERM must not exceed Vcc + 10%.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range (Vcc = 5.0V ± 10%)

			707278S		7072		
Symbol	Parameter	Test Conditions	Min.	Мах.	Min.	Мах.	Unit
Iu	Input Leakage Current ⁽¹⁾	Vcc = 5.5V, $Vin = 0V$ to Vcc	_	10	-	5	μA
ILO	Output Leakage Current	$\overline{\text{CE}} = \text{ViH}, \ \overline{\text{MBSEL}} = \text{ViH}, \ \text{Vout} = \text{OV to Vcc}$	_	10	-	5	μA
Vol	Output Low Voltage	IOL = +4mA	_	0.4	_	0.4	V
Voh	Output High Voltage	IOH = -4mA	2.4	_	2.4	_	٧

NOTE:

At Vcc ≤ 2.0V, input leakages are undefined.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range^(1,6) (Vcc = 5.0V ± 10%)

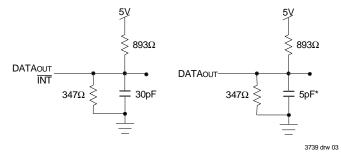
						8X15 Only	70727 Com'l		70727 Com'l		
Symbol	Parameter	Test Condition	Versi	on	Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Мах.	Typ. ⁽²⁾	Max.	Unit
Icc	Dynamic Operating Current (Both Ports Active)	CE = VIL, Outputs Disabled MBSEL = VIH f = MAX ⁽³⁾	COM'L	S L	220 220	350 300	200 200	340 290	190 190	330 280	mA
		T = IMAX*	IND	S L	1 1		250 250	370 320	240 240	360 310	
ISB1	Standby Current (Both Ports - TTL Level Inputs)	CEL = CER = VIH MBSELR = MBSELL = VIH f = fmax ⁽³⁾	COM'L	S L	50 50	90 65	45 45	90 65	40 40	90 65	mA
	ilipuis)		IND	S L			45 45	100 75	40 40	100 75	
ISB2	(One Port - TTL Level Inputs) Active Port Outputs Disabled,	COM'L	S L	130 130	230 200	120 120	215 185	110 110	200 170	mA	
		$\frac{f = f_{MAX}^{(3)}}{MBSEL_R} = \overline{MBSEL}_L = V_{IH}$	IND	S L	1 1		140 140	235 205	130 130	220 190	
ISB3	Full Standby Current (Both Ports - All CMOS Level Inputs)	Both Ports CEL and CER ≥ Vcc - 0.2V	COM'L	S L	1.5 1.5	15 5	1.5 1.5	15 5	1.5 1.5	15 5	mA
	ilipus)	$ \begin{array}{l} \text{Vin} \geq \text{Vcc} \cdot 0.2 \text{V or} \\ \frac{\text{Vin} \leq 0.2 \text{V, f} = 0^{(4)}}{\text{MBSELR}} = \frac{0^{(4)}}{\text{MBSELL}} \geq \text{Vcc} \cdot 0.2 \text{V} \end{array} $	IND	S L	-		1.5 1.5	30 10	1.5 1.5	30 10	
ISB4	(One Port - All CMOS Level Inputs) CEB ≥ Vcc - 0.2\\ MBSELR = MBS \\ VN ≥ Vcc - 0.2\\ N ≥ Vcc - 0.2\\ One Port - All CMOS Level CEB ≥ Vcc - 0.2\\ One Port - A	All CMOS Level $\overline{CE}_{B''} > V_{CC} - 0.2V^{(5)}$	COM'L	S L	145 145	230 195	135 135	210 180	130 130	200 170	mA
		$V_{IN} \ge V_{CC}$ - 0.2V or $V_{IN} \le 0.2V$ Active Port Outputs Disabled	IND	S L			135 135	230 200	130 130	220 190	

3739 tbl 10

- 1. 'X' in part numbers indicates power rating (S or L).
- 2. Vcc = 5V, TA = +25°C, and are not production tested. Iccdc = 120mA (Typ.)
- 3. At f = fMax, address and control lines (except Output Enable) are cycling at the maximum frequency read cycle of 1/ trc, and using "AC Test Conditions" of input levels of GND to 3V.
- 4. f = 0 means no address or control lines change.
- 5. Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- 6. Refer to Truth Table I.
- 7. Industrial temperature: for specific speeds, packages and powers contact your sales office.

AC Test Conditions

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	3ns Max.
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	Figures 1,2 and 3



3739 tbl 11

Figure 1. AC Output Test Load

Figure 2. Output Test Load (for tLz, tHz, twz, tow) *Including scope and jig.

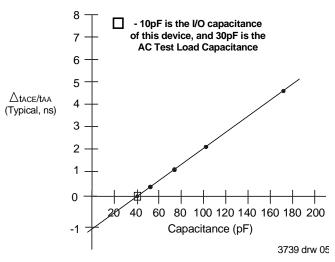


Figure 3. Lumped Capacitance Load Typical Derating Curve

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽⁴⁾

			78X15 I Only		78X20 & Ind		78X25 & Ind	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
READ CYCLE	•							
trc	Read Cycle Time	15		20		25		ns
taa	Address Access Time	_	15		20		25	ns
tace	Chip Enable Access Time ⁽³⁾	_	15		20		25	ns
tabe	Byte Enable Access Time ⁽³⁾	_	15	_	20	_	25	ns
taoe	Output Enable Access Time	_	9	_	10		11	ns
toн	Output Hold from Address Change	3		3	_	3		ns
tlz	Output Low-Z Time ^(1,2)	0		0	_	0		ns
tHZ	Output High-Z Time ^(1,2)	_	8		9		10	ns
tpu	Chip Enable to Power Up Time ^(2,5)	0		0	_	0		ns
tpD	Chip Disable to Power Down Time ^(2,5)	_	15		20	_	25	ns
tмор	Mailbox Flag Update Pulse (OE or MBSEL)	10		10	_	10	_	ns
tmaa	Mailbox Address Access Time	_	15		20		25	ns

NOTES:

- 1. Transition is measured 0mV from Low or High-impedance voltage with Output Test Load (Figure 2).
- 2. This parameter is guaranteed by device characterization, but is not production tested.
- 3. To access RAM, $\overline{CE} = VIL$ and $\overline{MBSEL} = VIH$. To access mailbox, $\overline{CE} = VIH$ and $\overline{MBSEL} = VIL$.
- 4. 'X' in part numbers indicates power rating (S or L).
- 5. Refer to Truth Table I.

Assigning the Banks via the External Bank Selects

There are four bank select pins available on the IDT707278, and each of these pins is associated with a specific bank within the memory array. The pins are user-controlled inputs: access to a specific bank is assigned to a particular port by setting the input to the appropriate level. The process of assigning the banks is detailed in Truth Table IV. Once a bank is assigned to a port, the owning port has full access to read and write within that bank. The opposite port is unable to access that bank until the user reassigns the port. Access by a port to a bank which it does not control will have no effect

if written, and if read unknown values on Do-D15 will be returned. Each port can be assigned as many banks within the array as needed, up to and including all four banks.

The bank select pin inputs must be set at either VIH or VIL - these inputs are not tri-statable. When changing the bank assignments, accesses of the affected banks must be suspended. Accesses may continue uninterrupted in banks that are not being reallocated.

Truth Table IV – Memory Bank Assignment (CE = Vін)^(2,3)

BKSEL0	BKSEL1	BKSEL2	BKSEL3	Bank and Direction ⁽¹⁾
Н	Х	Х	Х	BANK 0 LEFT
Х	Н	Х	Х	BANK 1 LEFT
Х	Х	Н	Х	BANK 2 LEFT
Х	Х	Х	Н	BANK 3 LEFT
L	Х	Х	Х	BANK 0 RIGHT
Х	L	Х	Х	Bank 1 Right
Х	Х	L	Х	BANK 2 RIGHT
Х	Х	Х	L	BANK 3 RIGHT

NOTES: 3739 tbl 13

- 1. Bank 0 refers to the first 8Kx16 memory spaces, Bank 1 to the second 8Kx16 memory spaces, Bank 2 to the third 8Kx16 memory spaces, and Bank 3 to the fourth 8Kx16 memory spaces. 'LEFT' indicates the bank is assigned to the left port; 'RIGHT' indicates the bank is assigned to the right port. 0-4 banks may be assigned to either port.
- The bank select pin inputs must be set at either V_{IH} or V_{IL} these inputs are not tri-statable. When changing the bank assignments, accesses of the affected banks must be suspended. Accesses may continue uninterrupted in banks that are not being reallocated.
- 3. 'H' = VIH, 'L' = VIL, 'X' = Don't Care.

Mailbox Interrupts and Interrupt Control Registers

If the user chooses the mailbox interrupt function, four mailbox locations are assigned to each port. These mail-box locations are external to the memory array. The mailboxes are accessed by setting $\overline{\text{MBSEL}} = \text{VIL}$ while holding $\overline{\text{CE}} = \text{VIH}$.

The mailboxes are 16 bits wide and controllable by byte: the message is user-defined since these are addressable SRAM locations. An interrupt is generated to the opposite port upon writing to the upper byte of any mailbox location. A port can read the message it has just written in order toverify it: this read will not alter the status of the interrupt sent to the opposite port. The interrupted port can clear the interrupt by reading the upper byte of the applicable mailbox. This read will not alter the contents of the mailbox. The use of mailboxes to generate interrupts to the opposite port and the reading of mailboxes to clear interrupts is detailed in Truth Table V.

If desired, any of the mailbox interrupts can be independently masked via software. Masking of the interrupt sources is done in the Mask Register.

The masks are individual and independent: a port can mask any combination of interrupt sources with no effect on the other sources. Each port can modify only its own Mask Register. The use of this register is detailed in Truth Table V.

Two registers are provided to permit interpretation of interrupts: these are the Interrupt Cause Register and the Interrupt Status Register. The Interrupt Cause Register gives the user a snapshot of what has caused the interrupt to be generated - the specific mailbox written to by the opposite port. The information in this register provides post-mask signals: interrupt sources that have been masked will not be updated. The Interrupt Status Register gives the user the status of all bits that could potentially cause an interrupt regardless of whether they have been masked. The use of the Interrupt Cause Register and the Interrupt Status Register is detailed in Truth Table V.

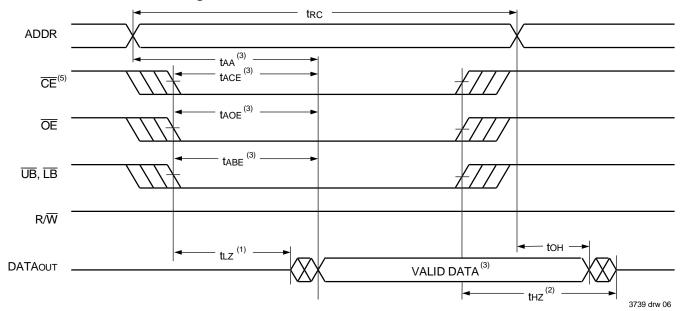
Truth Table V – Mailbox Interrupts ($\overline{CE} = V_{IH}$)(8,9)

MB SEL	R/W	ŪB	ĪΒ	A 5	A4	A3	A2	A 1	A0	D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15	DESCRIPTION
L	Χ	Χ	Χ	L	L	L	L	L	L	RE	SERV	ED (7)														RESERVED (7)
L	Χ	Χ	Χ	:	:	:	:	:		RE	SERV	ED (7)														RESERVED (7)
L	(1)	(1)	(1)	Н	L	L	L	L	L	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Х	Χ	Χ	Х	Χ	Χ	Χ	Χ	MAILBOX 0 - SET INTERRUPT ON OPPOSITE PORT
L	(1)	(1)	(1)	Н	L	L	L	L	Н	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	MAILBOX 1 - SET INTERRUPT ON OPPOSITE PORT
L	(1)	(1)	(1)	Н	L	L	L	Н	L	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	MAILBOX 2 - SET INTERRUPT ON OPPOSITE PORT
L	(1)	(1)	(1)	Н	L	L	L	Н	Н	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	MAILBOX 3 - SET INTERRUPT ON OPPOSITE PORT
1	Н	(2)	(2)	Н	L	L	Н	L	L	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	MAILBOX 0 - CLEAR OPPOSITE PORT INTERRUPT
1	Н	(2)	(2)	Н	L	L	Н	L	Н	Х	Χ	Χ	Х	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	Х	MAILBOX 1 - CLEAR OPPOSITE PORT INTERRUPT
1	Н	(2)	(2)	Н	L	L	Н	Н	L	Χ	Χ	Х	Х	Χ	Χ	Χ	Χ	Х	Χ	Χ	Х	Χ	Χ	Χ	Χ	MAILBOX 2 - CLEAR OPPOSITE PORT INTERRUPT
1	Н	(2)	(2)	Н	L	L	Н	Н	Н	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	Χ	MAILBOX 3 - CLEAR OPPOSITE PORT INTERRUPT
L	(3)	(3)	(3)	Н	L	Н	L	L	L	(4)	(4)	(4)	(4)	(5)	(5)	(5)	(5)	(6)	(6)	(6)	(6)	Χ	Χ	Χ	Χ	MAILBOX INTERRUPT CONTROLS
L	Χ	Χ	Χ	:	:	:	:	:	:	RESERVED (7)							RESERVED (7)									
L	Х	Χ	Χ	Н	Н	Н	Н	Н	Н	RE	SERV	ED (7)														RESERVED (7)

NOTES:

- 1. There are four independent mailbox locations available to each side, external to the standard memory array. The mailboxes can be written to in either 8-bit or 16-bit widths. The upper byte of each mailbox has an associated interrupt to the opposite port. The mailbox interrupts can be individually masked if desired, and the status of the interrupt determined by polling the Interrupt Status Register (see Note 6 for this table). A port can read its own mailboxes to verify the data written, without affecting the interrupt which is sent to the opposite port.
- 2. These registers allow a port to read the data written to a specific mailbox location by the opposite port. Reading the upper byte of the data in a particular mailbox clears the interrupt associated with that mailbox without modifying the data written. Once the address and R/W are stable, the actual clearing of the interrupt is triggered by the transition of MBSEL from VIH to VIL.
- 3. This register contains the Mask Register (bits Do-D3), the Interrupt Cause Register (bits D4-D7), and the Interrupt Status Register (bits D8-D11). The controls for R/W, UB, and LB are manipulated in accordance with the appropriate function. See Notes 4, 5, and 6 for this table. Bits D12-D15 are "Don't Care".
- 4. This register, the Mask Register, allows the user to independently mask the various interrupt sources. Writing V_{IH} to the appropriate bit (D₀ = Mailbox 0, D₁ = Mailbox 1, D₂ = Mailbox 2, and D₃ = Mailbox 3) disables the interrupt, while writing V_{IL} enables the interrupt. All four bits in this register must be written at the same time. This register can be read at any time to verify the mask settings. The masks are individual and independent: any single interrupt source can be masked with no effect on the other sources. Each port can modify only its own mask settings.
- 5. This register, the Interrupt Cause Register, gives the user a snapshot of what has caused the interrupt to be generated. Reading Vol for a specific bit (D4 = Mailbox 0, D5 = Mailbox 1, D6 = Mailbox 2, and D7 = Mailbox 3) indicates that the associated interrupt source has generated an interrupt. Acknowledging the interrupt clears the bit in this register (see Note 2 for this table). This register provides post-mask information: if the interrupt source has been masked, the associated bit in this register will not update.
- 6. This register, the Interrupt Status Register, gives the user the status of all interrupt sources that could potentially cause an interrupt regardless of whether they have been masked. Reading Vol. for a specific bit (D8 = Mailbox 0, D9 = Mailbox 1, D10 = Mailbox 2, and D11 = Mailbox 3) indicates that the associated interrupt source has generated an interrupt. Acknowledging the interrupt clears the associated bit in this register (see Note 2 for this table). This register provides pre-mask information: regardless of whether an interrupt source has been masked, the associated bit in this register will update.
- 7. Access to registers defined as "RESERVED" will have no effect, if written, and if read unknown values on Do-D15 will be returned.
- 8. These registers are not guaranteed to initialize in any known state. At power-up, the initialization sequence should include the set-up of these registers.
- 9. 'L' = VIL or Vol, 'H' = VIH or Voh, 'X' = Don't Care.

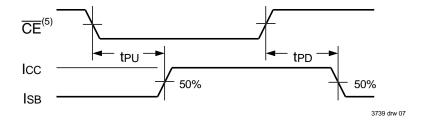
Waveform of Read Cycles⁽⁴⁾



NOTES

- 1. Timing depends on which signal is asserted last, $\overline{\text{CE}}$, $\overline{\text{OE}}$, $\overline{\text{LB}}$, or $\overline{\text{UB}}$.
- 2. Timing depends on which signal is de-asserted first \overline{CE} , \overline{OE} , \overline{LB} , or \overline{UB} .
- 3. Start of valid data depends on which timing becomes effective last: taoe, tace, tabe, or taa.
- 4. $\overline{\text{MBSEL}} = \text{ViH}$.
- 5. Refer to Truth Table I.

Timing of Power-Up Power-Down



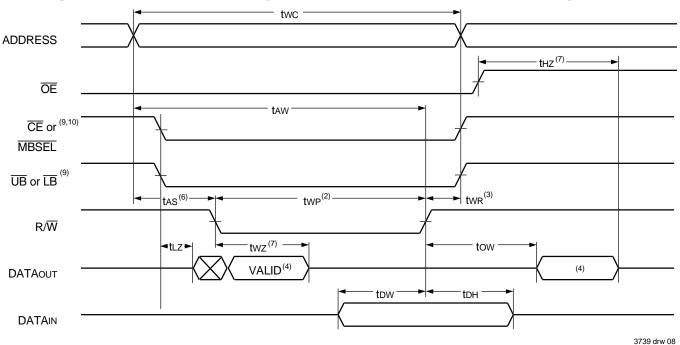
AC Electrical Characteristics Over the Operating Temperature and Supply Voltage⁽⁵⁾

			78X15 I Only		78X20 & Ind	7072 Com'l		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
WRITE CYCLI	E							
twc	Write Cycle Time	15	_	20	_	25	_	ns
tew	Chip Enable to End-of-Write ⁽³⁾	12	_	15	_	20	_	ns
taw	Address Valid to End-of-Write	12	_	15	_	20	_	ns
tas	Address Set-up Time ⁽³⁾	0	_	0	_	0	_	ns
tBS	Bank Set-up Time	0	_	0	_	0	_	ns
twp	Write Pulse Width	12	_	15	_	20	_	ns
twr	Write Recovery Time	0	_	0	_	0	_	ns
tow	Data Valid to End-of-Write	15	_	15	_	20	_	ns
tHZ	Output High-Z Time ^(1,2)	_	8	_	9	_	10	ns
tон	Data Hold Time ⁽⁴⁾	0	_	0	_	0	_	ns
twz	Write Enable to Output in High-Z ^(1,2)	_	8	_	9	_	10	ns
tow	Output Active from End-of-Write ^(1,2,4)	3	_	3		3		ns
tmwrd	Mailbox Write to Read Time	5	_	5	_	5	_	ns

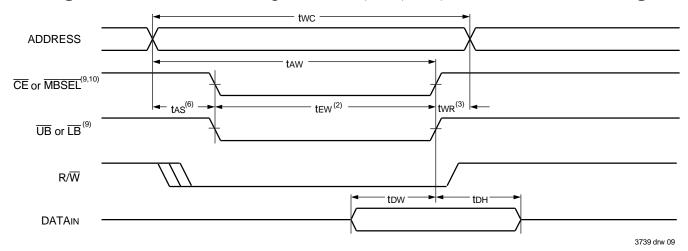
NOTES: 3739 tbl 15

- 1. Transition is measured 0mV from Low or High-impedance voltage with Output Test Load (Figure 2).
- 2. This parameter is guaranteed by device characterization, but is not production tested.
- 3. To access RAM, $\overrightarrow{CE} = VIL$ and $\overrightarrow{MBSEL} = VIH$. To access mailbox, $\overrightarrow{CE} = VIH$ and $\overrightarrow{MBSEL} = VIL$. Either condition must be valid for the entire tew time. Refer to Truth Tables I and III.
- 4. The specification for toh must be met by the device supplying write data to the RAM under all operating conditions. Although toh and tow values will vary over voltage and temperature, the actual toh will always be smaller than the actual tow.
- 5. 'X' in part numbers indicates power rating (S or L).

Timing Waveform of Write Cycle No. 1, R/\overline{W} Controlled Timing^(1,5,8)

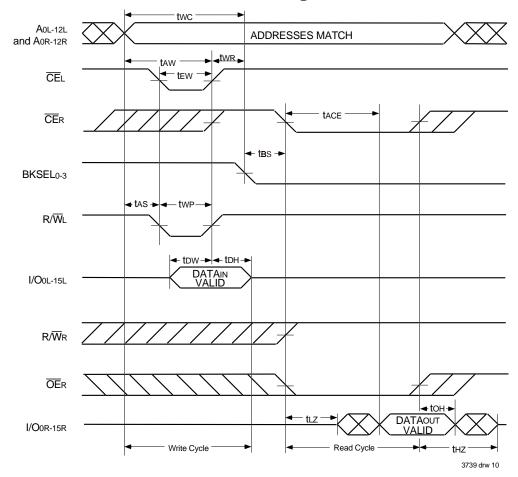


Timing Waveform of Write Cycle No. 2, $\overline{\text{CE}}$, $\overline{\text{UB}}$, $\overline{\text{LB}}$ Controlled Timing^(1,5)



- 1. R/\overline{W} or \overline{CE} or \overline{UB} and \overline{LB} = VIH during all address transitions.
- 2. A write occurs during the overlap (tew or twp) of a $\overline{CE} = V_{IL}$ and a $R/\overline{W} = V_{IL}$ for memory array writing cycle.
- 3. twn is measured from the earlier of $\overline{\text{CE}}$ or $\overline{\text{RW}}$ (or $\overline{\text{MBSEL}}$ or $\overline{\text{RW}}$) going to VIL to the end of write cycle.
- 4. During this period, the I/O pins are in the output state and input signals must \underline{not} be applied.
- 5. If the CE or MBSEL = VIL transition occurs simultaneously with or after the R/W = VIL transition, the outputs remain in the High-impedance state.
- 6. Timing depends on which enable signal is asserted last, $\overline{\text{CE}}$ or R/\overline{W} .
- 7. This parameter is guaranteed by device characterization, but is not production tested. Transition is measured 0mV from steady state with the Output Test Load (Figure 2).
- 8. If $\overline{OE} = VIL$ during R/W controlled write cycle, the write pulse width must be the larger of twp or (twz + tow) to allow the I/O drivers to turn off and data to be placed on the bus for the required tow. If $\overline{OE} = VIH$ during an R/W controlled write cycle, this requirement does not apply and the write pulse can be as short as the specified twp.
- 9. To access RAM, $\overline{\text{CE}} = \text{V}_{\text{IL}}$ and $\overline{\text{MBSEL}} = \text{V}_{\text{IH}}$. To access mailboxes, $\overline{\text{CE}} = \text{V}_{\text{IH}}$ and $\overline{\text{MBSEL}} = \text{V}_{\text{IL}}$. tew must be met for either condition.
- 10. Refer to Truth Table I.

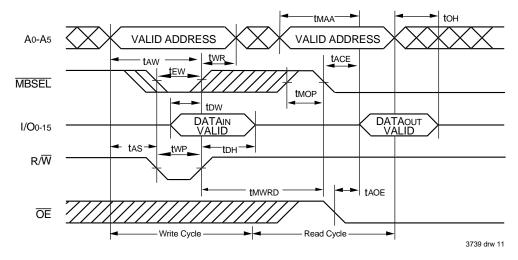
Timing Waveform of Left Port Write to Right Port Read of Same Data^(1,2,3)



NOTES:

- 1. $\overline{\text{UB}}$ and $\overline{\text{LB}}$ are controlled as necessary to enable the desired byte accesses.
- 2. Timing for Right Port Write to Left Port Read is identical.
- 3. Refer to Truth Table I and IV.

Timing Waveform of Mailbox Read after Write Timing, Either Side^(1,2)



- 1. \overline{CE} = VIH for the duration of the above timing (both write and read cycle), refer to Truth Table I.
- UB and LB are controlled as necessary to enable the desired byte accesses.

3739 tbl 16

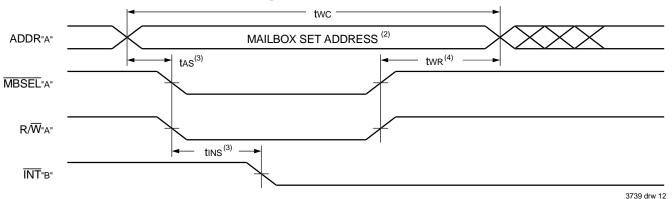
AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽¹⁾

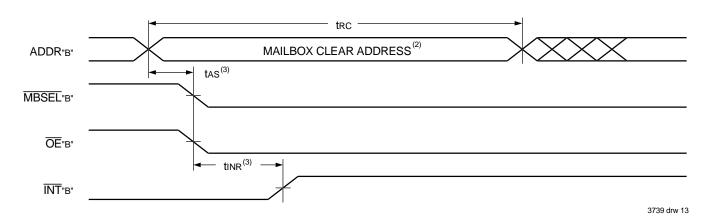
			78X15 I Only		78X20 I & Ind	7072 Com'l		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
INTERRUPT T	IMING							
tas	Address Set-up Time	0	_	0	_	0	_	ns
twr	Write Recovery Time	0	_	0	_	0	_	ns
tins	Interrupt Set Time	_	15	_	20	_	25	ns
tinr	Interrupt Reset Time	_	15	_	20	_	25	ns

NOTES:

1. 'X' in part numbers indicates power rating (S or L).

Waveform of Interrupt Timing^(1,5)





- 1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".
- 2. See Interrupt Truth Table V.
- 3. Timing depends on which enable signal $(\overline{CE} \text{ or } R/\overline{W})$ is asserted last.
- 4. Timing depends on which enable signal $(\overline{CE} \text{ or } R/\overline{W})$ is de-asserted first.
- 5. Refer to Truth Table I.

Depth and Width Expansion

The IDT707278 features dual chip enables (refer to Truth Table I) in order to facilitate rapid and simple depth expansion with no requirements for external logic. Figure 4 illustrates how to control the various chip enables in order to expand two devices in depth.

The IDT707278 can also be used in applications requiring expanded

width, as indicated in Figure 4. Since the banks are allocated at the discretion of the user, the external controller can be set up to drive the input signals for the various devices as required to allow for 32-bit or wider applications.

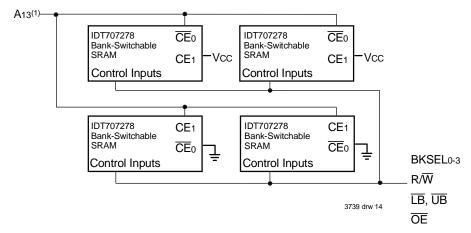
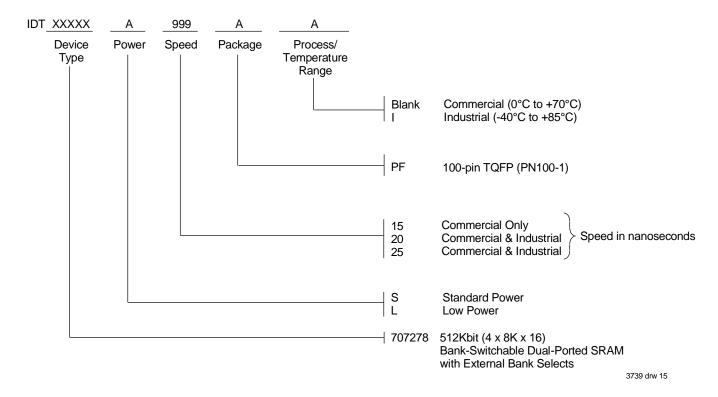


Figure 4. Depth and Width Expansion with IDT707278

NOTE:

1. This signal is provided by external logic. It is not a bit present on the address bus.

Ordering Information



Datasheet Document History

1/8/99: Initiated datasheet document history

Converted to new format

Cosmetic and typographical corrections

Page 2 Added additional notes to pin configurations

3/11/99: Removed preliminary note

Cosmetic and typographical corrections

6/4/99: Changed drawing format

Page 1 Corrected DSC number

3/10/00: Added Industrial Temperature Ranges and removed corresponding notes

Replaced IDT logo

Page 1 Made overbar correction in drawing

Changed ±200mV to 0mV in notes

5/23/00: Page 5 Increased storage temperature parameter

Clarified TA parameter

Page 6 DC Electrical parameters—changed wording from open to disabled



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